



## **Description:**

RoHS Compliant

WTC soft termination series MLCC is designed and with a polymer layer within end terminations of product, which can absorb mechanical stress caused by PCB handling in SMT line and reduce the mechanical impact for product. It will offer more robust and reliable performance in applications.

### Features:

- MLCC's termination are with a soft & flexible polymer layer to withstand high bending stress in SMT line.
- · Available for any item in standard series range.

### **Applications:**

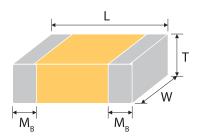
- · Automotive industry.
- · Power supply and related industries.
- · Lighting industry.
- · The other mechanical stress concerned products.

### **How To Order:**

MCSH	31	В	104	K	500	С	Т
Series	Size	Dielectric	Capacitance	Tolerance	Rated Voltage	Termination	Packaging
Multicomp SH=Soft termination	15=0402 (1005) 18=0603 (1608) 21=0805 (2012) 31=1206 (3216) 32=1210 (3225) 43=1812 (4532)	N= NP0 (C0G) B=X7R X=X5R F=Y5V	Two significant digits followed by no. of zeros. And R is in place of decimal point.  Eg. 104 =10x104 =100nF	B=±0.1pF C=±0.25pF D=±0.5pF F=±1% G=±2% J=±5% K=±10% M=±20% Z=-20/+80%	Two significant digits followed by no. of zeros. And R is in place of decimal point.  6R3=6.3V DC 100=10V DC 160=16V DC 250=25V DC 500=50V DC 101=100V DC	C=Cu/ Polymer/Ni/ Sn	T=7" reeled G=13" reeled

Note 1: Please see below product range to find right termination code.

#### **External Dimensions:**



The outline of MLCC

Size Inch (mm)	L (mm)	W (mm)	T (mm)/Syı	mbol	Remark	M <sub>B</sub> (mm)
0402 (1005)	1±0.2	0.5±0.2	0.5±0.2	Е		0.25 +0.05/-0.1
	1.6±0.2	0.8±0.1	0.80±0.07	S		
0603 (1608)	1.6 +0.2/-0.1	0.8 +0.15/-0.1	0.8 +0.15/-0.1	Х		0.40±0.15

<sup>#</sup> Reflow soldering only is recommended.





Size Inch (mm)	L (mm)	W (mm)	T (mm)/Sy	mbol	Remark	M <sub>B</sub> (mm)	
			0.6±0.1	Α			
0005 (0040)	2±0.2	1.25±0.1	0.8±0.1	В		0.5±0.2	
0805 (2012)			1.25±0.1	D	#		
	2+0.25/-0.2	1.25±0.2	1.25±0.2	I	#		
			0.8±0.1	В			
	3.2+0.4/-0.1	1.6±0.15	0.95±0.1	С	#	0.6±0.2	
			1.15±0.15	J	#		
1206 (3216)			1.25±0.1	D	#		
	3.2+0.4/-0.1	1.6±0.2	1.6±0.2	G	#		
	3.2+0.4/-0.1	1.6+0.3/0.1	1.6+0.3/- 0.1	Р	#		
	2 2 1 0 4	0.5.0.0	0.95±0.1	С	#		
	3.2±0.4	2.5±0.2	1.25±0.1	D	#	1	
1210 (3225)			1.6±0.2	G	#	0.75±0.25	
	3.2±0.5	2.5±0.3	2±0.2	K	#		
			2.5±0.3	М	#		
1812 (4532)	4.5+0.6/-0.4	3.2±0.3	1.25±0.1	D	#	0.75±0.25	

<sup>#</sup> Reflow soldering only is recommended.

### **General Electrical Data:**

Dielectric	NP0	X7R	X5R	Y5V		
Size	04	402, 0603, 0805, 120	6, 1210, 1812			
Capacitance range*	0.1pF to 0.015μF	100pF to 10μF	100pF to 10μF			
Capacitance tolerance**	Cap≤5pF: B (±0.1pF), C (±0.25pF) 5pF <cap<10pf: (±0.25pf),="" (±0.5pf)="" (±1%),="" (±10%)<="" (±2%),="" (±5%),="" c="" cap≥10pf:="" d="" f="" g="" j="" k="" th=""><th>K (±10%),</th><th>Z (-20/+80%)</th></cap<10pf:>	K (±10%),	Z (-20/+80%)			
Rated voltage (WVDC)		6.3V, 10V, 16V, 25V,	50V, 100V			
Operating temperature	-55 to +125°C	-55 to +125°C	-55 to +85°C	-25 to +85°C		
Capacitance characteristic	±30ppm	±15%	±15%	+30/-80%		
Termination	Ni/Sn (lead-free termination)					

<sup>\*</sup> Measured at the condition of 30~70% related humidity.

NP0: Apply 1±0.2Vrms, 1MHz±10% for Cap≤1,000pF and 1±0.2Vrms, 1kHz±10% for Cap>1,000pF, 25°C at ambient temperature X7R, X5R: Apply 1±0.2Vrms, 1kHz±10%, at 25°C ambient temperature.

<sup>\*\*</sup> Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement.



Y5V: Apply 1±0.2Vrms, 1kHz±10%, at 20°C ambient temperature.



# **Packaging Style and Quantity:**

0:	TI 1.1		Раре	er tape	Plast	ic tape
Size	Thickness (mm)/S	Symbol	7" reel	13" reel	7" reel	13" reel
0402 (1005)	0.5±0.2	E	10k	-	-	-
0002 (4000)	0.8±0.07	S	4k	15k	-	-
0603 (1608)	0.8+0.15/-0.1	X	4k	15k	-	-
	0.6±0.1	Α	4k	15k	-	-
0905 (2012)	0.8±0.1	В	4k	15k	-	-
0805 (2012)	1.25±0.1	D	-	-	3k	10k
	1.25±0.2	I	-	-	3k	10k
	0.8±0.1	В	4k	15k	-	-
	0.95±0.1	С	-	-	3k	10k
1206 (2216)	1.15±0.15	J	-	-	3k	10k
1206 (3216)	1.25±0.1	D	-	-	3k	10k
	1.6±0.2	G	-	-	2k	10k
	1.6+0.3/-0.1	Р	-	-	2k	9k
	0.95±0.1	С	-	-	3k	10k
	1.25±0.1	D	-	-	3k	10k
1210 (3225)	1.6±0.2	G	-	-	2k	-
	2±0.2	K	-	-	1k	6k
	2.5±0.3	M	-	-	1k	6k
1010 (4520)	1.25±0.1	D	-	-	1k	5k
1812 (4532)	2±0.2	K	-	-	1k	- Unit: piece:

# **Reliability Test Conditions and Requirements:**

No	Item	Test Condition	Requirements
1	Visual and Mechanical	-	*No remarkable defect. *Dimensions to conform to individual specification sheet.



No	Item	Test Condition			Re	equirements
			NP0: Ca	ap≥30pF	, Q≥1000	; Cap<30pF,Q≥400+20C
			X7R,X5	R,X6S:		
			Rated vo	DIF. ≦	Exception	of D.F.≦
			>100\/	-2 F0/	≦3%	1206≧0.47µF
			≧100V	≦2.5%	≦5%	0805≧0.1μF, 0603≧0.068μF
	Capacitance				≦3%	0201(50V); 0603≧0.047µF; 0805≧0.18µF;1206≧0.47µF
		Class I: NP0	50V	2.5%	≦5%	1210≧4.7µF
		Cap≤1,000pF 1±0.2Vrms, 1MHz±10% Cap>1,000pF 1±0.2Vrms, 1KHz±10% Class II: X7R, X5R, X6S,Y5V Cap≤10µF, 1±0.2Vrms, 1kHz±10% **			≦10%	0402≧0.1μF; 0603≧1μF; 0805≧1μF; 1206≧2.2μF; 1210≧10μF; TT series
			35V	≦3.5%	≦10%	0603≧1μF;0805≥2.2μF; 1210≧10μF
		Cap>10µF, 0.5±0.2Vrms, 120Hz±20%			≦5%	0201≧0.01μF;0805≧1μF; 1210≧10μF
		** Test condition: 0.5±0.2Vrms,	25V	≦3.5%	≦7%	0603≧0.33μF; 1206≧4.7μF
2					≦10%	0402≧0.1μF;0603≧0.47μF; 0805≧2.2μF; 1206≧6.8μF; 1210≧22μF; TT series
_	- Capacitaire				≦12.5%	0402≧1µF
					≦5%	0201≧0.01μF; 0402≧0.033μF; 0603≧0.15μF; 0805≧0.68μF 1206≧2.2μF; 1210≧4.7μF
			16V	≦3.5%	≦10%	0201≧0.1μF; 0402≧0.22uF; 0603≧0.68μF; 0805≧2.2μF; 1206≧4.7μF; 1210≧22μF; TT series
			10V	≦5%	≦10%	0201≧0.012μF; 0402≧0.33μF; 0603≧0.33μF; 0805≧2.2μF; 1206≧2.2μF; 1210≧22μF; TT series
					≦15%	0201≧0.1μF; 0402≧1μF
			6.3V	≦10%	≦15%	0201≧0.1μF; 0402≧1μF; 0603≧10μF; 0805≧4.7μF; 1206≧47μF :1210≧100μF; TT series
					≦20%	0402≧2.2μF
			4V	≦15%	-	-





No	Item	Test Condition			Requi	irements		
			Y5V:					
			Rated vo	DIF. ≦	Exception	of D.F.≦		
			≧50V	5%	7%	0603≧0.1µF; ( 1206≥		
			35V	7%	-	-		
	Q/ D.F.		25V	5%	7%	0402≧0.047µF 0805≧0.33µF 1210≧	; 1206≧1µF;	
3	(Dissipation Factor)				9%	0402≥0.068μF; 0603≥0.47μF 1206≥4.7μF; 1210≥22μF		
	,		16V	7%	9%	0402≧0.068µF	; 0603≧0.68µF	
			(C<1µF)	1 70	12.5%	0402≧0	).22µF	
			16V (C≧1µF)	9%	12.5%	0603≧ 0805≧3.3µF; 1210≧22µF;	1206≧10µF;	
			10V	12.5%	20%	0402≧0	).47µF	
			6.3V	20%	-	-		
4	Dielectric Strength	To apply voltage (≤100V) 250%.  Duration: 1 to 5 sec.  Charge and discharge current less than  50mA	No evidence of damage or flash over during test.					
			10GΩ or RxC≧500Ω-F whichever is smaller. Class II (X7R, X5R, X6S, Y5V)					
				Rate	ed voltage	Э	Insulation Resistance	
					0V: X7R			
			50V:0603≥1μF; 0805≥1μF; 1206≥4.7μF; 1210≥4.7μF					
			35\	I0≧10μF	10GΩ or			
5	Insulation	To apply rated voltage for max. 120 sec.		F; 0805≥2.2µF; ≥10µF	RxC≧100Ω-F whichever is			
	Resistance			603≥1µF; ;1210≥47µF	smaller.			
			10V:0201≥ 0805≥					
			6.3V ; 4V					
			50V: 0402≥0.1μF				10GΩ or	
					0603≥1µ		RxC≧50Ω-F	
			10V:0603≥10µF				whichever is smaller.	
			4V:0603≥22μF; 0805≥47μF					







No	Item		Test Conditi	on			Requirement	ts		
		With no	electrical load.							
		T.C.	Operating T	emp		T.C.	Capacitance Change	]		
		NPO	-55~125°C at			NPO	Within ±30ppm/°C	1		
6	Temperature Coefficient	X7R	-55~125°C at	t 25°C		X7R	Within ±15%	1		
		X5R	-55∼ 85°C at	25°C		X5R	Within ±15%	]		
		X6S	-55~105°C at	t 25°C		X6S	Within ±22%	]		
		Y5V	-25∼ 85°C at	20°C		Y5V	Within +30%/-80%	]		
7	Adhesive Strength of Termination	5N	Pressurizing for 100 (≤0603) and 10N Test time: 10±1	V (>0603)		No remark	able damage or removal	of the terminations.		
8	Vibration Resistance	Vibration frequency: 10~55 Hz/min. Total amplitude: 1.5mm Test time: 6 hrs. (Two hrs each in three mutually perpendicular directions.) Measurement to be made after keeping at room temp. for 24±2 hrs.			No remarkable damage. Cap change and Q/D.F.: To meet initial spec.					
9	Solderability	Solder temperature: 235±5°C Dipping time: 2±0.5 sec.			95% min. coverage of all metalized area.					
10	Bending Test	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1mm per second until the deflection becomes:  5mm and then the pressure shall be maintained for 5±1 sec.  Measurement to be made after keeping at room temp. for 24±2 hrs.			ır- er s: e	No remarkable damage. Cap change: NP0: within ±5% or 0.5pF whichever is larger X7R, X5R, X6S: within ±12.5% Y5V: within ±30% (This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance				
11	Resistance to Soldering Heat	Prehea before Before only): Po then s Measure	Ider temperature: Dipping time: 10: ting: 120 to 150°0 re immerse the ca eutectic sold e initial measuren erform 150+0/-10 set for 24±2 hrs ar ement to be made	±1 sec C for 1 minuapacitor in a er. nent (Class °C for 1 hr a t room tempe e after keep	II and	measured before the test.)  No remarkable damage. Cap change: NP0: within ±2.5% or 0.25pF whichever is larger X7R, X5R, X6S: within ±7.5% Y5V: within ±20% Q/D.F., I.R. and dielectric strength: To meet initial requirements. 25% max. leaching on each edge.				
		* Conduct the five cycles according to the temperatures and time.    Step   Temp. (°C)   Time (min.)			No remarkable damage. Cap change: NP0: within ±2.5% or 0.25pF whichever is larger					
12	Temperature	1	Min. operating temp. +0/-3	30±3	,	X7R, X5R, Y5V: within	To meet initial			
-	Cycle	2	Room temp.	2~3	]	requireme				
		3	Max. operating temp. +3/-0	30±3						
		4	Room temp.	2~3						







No	Item	Test Condition			R	equirements	
	Temperature Cycle	Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 24±2 hrs at room temp.  Measurement to be made after keeping at room temp. for 24±2 hrs.					
			No remarkable damage. Cap change: NP0: within $\pm 5\%$ or 0.5pF whichever is larger X7R, X5R, X6S: $\geq 10V^{**}$ , within $\pm 12.5\%$ ; $\leq 6.3V$ within $\pm 25\%$ TT series & C $\geq 1$ uF, within $\pm 25\%$ 10V: $0603 \geq 4.7 \mu$ F; $0402 \geq 1 \mu$ F; $0201 \geq 0.1 \mu$ F, within $\pm 25\%$ ; Y5V: $\geq 10V$ , within $\pm 30\%$ ; $\leq 6.3V$ , within $\pm 30/-40\%$ Q/D.F. value: NP0: More than $30$ pF Q $\geq 350$ , $10$ pF $\leq C \leq 30$ pF, Q $\geq 275+2.5C$ Less than $10$ pF Q $\geq 200+10C$ X7R, X5R, X6S:				
			Rated	D.F.≦		Exception of D.F.≦	
		Test temp.: 40±2°C Humidity: 90~95% RH Test time: 500+24/-0hrs.	≥100V	≦3%	≦6%	1206≧0.47µF	
			≧100√	≧370	≦7.5%	0805≧0.1μF, 0603≧0.068μF	
	Humidity				≦6%	0201(50V);0603≧0.047µF; 0805≧0.18µF; 1206≧0.47µF	
			≧50V	≦3%	≦10%	1210≧4.7μF	
					≦20%	0402≧0.1μF;0603≧1μF; 0805≧1μF; 1206≧2.2μF; 1210≧10μF; TT series	
13	(Damp Heat)	Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and	35V	≦5%	≦20%	0603≧1μF; 0805≥2.2μF;1210≧10μF	
	Steady State	then set for 24±2 hrs at room temp.			≦10%	0201≧0.01μF;0805≧1μF; 1210≧10μF	
		Measurement to be made after keeping			≦14%	0603≧0.33μF;1206≧4.7μF	
		at room temp. for 24±2 hrs.	25V	≦5%	≦15%	0402≧0.10μF;0603≧0.47μF;0805≧2.2μF; 1206≧6.8μF; 1210≧22μF; TT series	
					≦20%	0402≧1μF	
					≦10%	0603≧0.15µF;0805≧0.68µF;1206≧2.2µF; 1210≧4.7µF	
			16V	≦5%	≦15%	0201≧0.01μF;0402≧0.033μF;0603≧0.68μ F;0805≧2.2μF; 1206≧4.7μF; 1210≧22μF; TT series	
			10V	<b>≦7.5%</b>	≦15%	0201≧0.012μF; 0402≧0.33μF; 0603≧0.33μF;0805≧2.2μF; 1206≧2.2μF; 1210≧22μF	
					≦20%	0201≧0.1μF ;0402≧1μF; TT series	
			6.3V	≦15%	≦30%	0201≥0.1μF;0402≥1μF;0603≥10μF; 0805≥4.7μF;1206≥47μF;1210≥100μF; TT series	
			4V	≦20%	-	-	



No	Item	Test Condition			Requi	rements	
			Y5V:				
			Rated vo	DIF. ≦	Exception	of D.F.≦	
			≧50V	5%	7%		F; 0805≧0.47µF; 6≧4.7µF
			35V	7%	-		-
			25V	5%	7%	0805≧0.33	μF; 0603≧0.1μF; μF; 1206≧1μF; 0≧4.7μF
					9%		uF; 0603≧0.47μF; uF; 1210≧22μF
			16V	7%	9%	0402≧0.068ן	μF; 0603≧0.68μF
			(C<1µF)	1 70	12.5%	0402	2≧0.22µF
			16V (C≥1µF)	9%	12.5%	0805≧3.3µ	3≧2.2µF; ıF; 1206≧10µF; ıF;1812≧47µF
			10V	12.5%	20%	0402≧0.47µF	
			6.3V	20%	-		
			*I.R.: ≥10V Class II (X	•		hichever is sn /)	naller.
				Rated	d voltage		Insulation Resistance
				100	V: X7R		
					0603≥1µF F;1210≥4	F;0805≥1μF; 7μF	
			0.		603≥1µF F;1210≧′		
					603≥2.2μ μF; F;1210≥1	F;0805≥2.2 0µF	1GΩ or RxC≧10 Ω-F
			whichever is smaller. $μF;$ $1206≥10μF;1210≥47μF$				
				4	7μF;	′μF;0603≥0. 1210≥47μF	
			3333=2.		8V; 4V	v=.r.pr	



No	Item	Test Condition			R	equirements
			No remarkable damage. Cap change: NP0: $\pm 7.5\%$ or 0.75pF whichever is larger. X7R, X5R, X6S: $\geq 10V^{**}$ , within $\pm 12.5\%$ ; $\leq 6.3V$ within $\pm 25\%$ ; TT series & C $\geq$ 1uF, within $\pm 25\%$ **10V: $0603 \geq 4.7 \mu$ F; $0402 \geq 1 \mu$ F; $0201 \geq 0.1 \mu$ F, within $\pm 25\%$ ; Y5V: $\geq 10V$ , within $\pm 30\%$ ; $\leq 6.3V$ , within $\pm 30/-40\%$ Q/D.F. value: NP0: C $\geq 30$ pF, Q $\geq 200$ ; C $\leq 30$ pF, Q $\geq 100+10/3$ C X7R, X5R, X6S:			
			Rated	D.F.≦		Exception of D.F.≦
					≦6%	1206≧0.47µF
			≧100V	≦3%	≦7.5%	0805≧0.1µF, 0603≧0.068µF
			≧50V		≦6%	0201(50V);0603≧0.047μF; 0805≧0.18μF; 1206≧0.47μF
		Test temp.: 40±2°C Humidity: 90~95%RH		≦3%	≦10%	1210≧4.7μF
		idity Heat)  Test time: 500+24/-0 hrs. To apply voltage: rated voltage. Before initial measurement (Class II			≦20%	0402≧0.1μF;0603≧1μF; 0805≧1μF; 1206≧2.2μF; 1210≧10μF; TT series
4.4	Humidity		35V	≦5%	≦20%	0603≧1μF; 0805≥2.2μF;1210≧10μF
14	(Damp Heat) Load		25V		≦10%	0201≧0.01μF;0805≧1μF; 1210≧10μF
					≦14%	0603≧0.33μF;1206≧4.7μF
				≦5%	≦15%	0402≧0.10µF;0603≧0.47µF;0805≧2.2µF; 1206≧6.8µF; 1210≧22µF; TT series
					≦20%	0402≧1μF
					≦10%	0603≧0.15μF;0805≧0.68μF;1206≧2.2μF; 1210≧4.7μF
			16V	≦5%	≦15%	0201≥0.01μF;0402≥0.033μF;0603≥0.68μ F;0805≥2.2μF; 1206≥4.7μF; 1210≥22μF; TT series
			10V	<b>≦7.5%</b>	≦15%	0201≧0.012μF; 0402≧0.33μF; 0603≧0.33μF;0805≧2.2μF; 1206≧2.2μF; 1210≧22μF
					≦20%	0201≧0.1μF ;0402≧1μF; TT series
			6.3V	≦15%	≦30%	0201≧0.1μF;0402≧1μF;0603≧10μF; 0805≧4.7μF;1206≧47μF;1210≧100μF; TT series
			4V	≦20%	-	-



No	Item	Test Condition			Requ	irements		
			Y5V:					
			Rated vol.	D.F.≦		Exception of D	.F.≦	
			≥50V	7.5%	10%	0603≧0 0805≧0.47µF;		
			35V	10%	-	-		
			25V	7.5%	10%	0402≧0.047μF; 0805≧0.33μF 1210≥4	ıF;1206≧1μF;	
					15%	0402≧0.068μF; 1206≧4.7μF;		
			16V	10%	12.5%	0402≧0.068µF;	0603≧0.68µF	
			(C<1µF)	10 /6	20%	0402≧0.22µF		
			16V (C≧1µF)	12.5%	20%	0603≧2.2µF; 0 1206≧10µF;1 1812≧4	210≧22µF;	
			10V	20%	30%	0402≧0	.47μF	
			6.3V	30%	-	-		
			I.R.: ≥10V, Class II (X			= whichever is sm 5V)	aller.	
				Rat	ed voltaç	је	Insulation Resistance	
				10	00V: X7R	1		
			50V:060	50V:0603≥1μF; 0805≥1μF; 1206≥4.7μF; 1210≥4.7μF				
				35V:0805≥2.2μF; 1210≧10μF			500140	
				25V:0402≥1µF; 0603≥2.2µF; 0805≥2.2µF; R×C≥		500MΩ or R×C≧5Ω-F whichever is		
				0603≥1µF; F;1210≥47µF	smaller.			
				10V:0201≥47nF; 0402≥0.47µF; 0603≥0.47µF; 0805≥2.2µF; 1206≥4.7µF; 1210≥47µF				
				6	.3V ; 4V			



No	Item	Test Condition						R	Requirements	
		X6S: T (1) ≤6. (2) 10V≤ (3) 5 (4) Uri (5)	NP0, X7R/2 105±3°C; rest time: 1 To appl 3V or C≥1 vol €Ur<500V: 2 500V: 150% ≥630V: 120 ) 100% of r below	X5R, Y5\ 000+24/- ly voltage 0µF: 150 ltage. 200% of rated 0% of rated rated voltage.	/: 85±3°C 0 hrs. :: 19% of rated ated voltage. voltage. ed voltage. age for	Cap cha NP0: ± X7R, x ±25%; TT ser **10V: Y5V: ≥ Q/D.F. NP0: N 10pF≤	No remarkable damage. Cap change: NP0: ±3.0% or ±0.3pF whichever is larger X7R, X5R, X6S: ≥10V**,within ±12.5%; ≥6.3V within ±25%; TT series & C≥ 1uF,within ±25% **10V: 0603≥4.7µF;0402≥1µF;0201≥0.1µF, within ±25 Y5V: ≥10V, within ±30%; ≤6.3V, within +30/-40% Q/D.F. value: NP0: More than 30pF, Q≥350 10pF≤C<30pF, Q≥275+2.5C Less than 10pF, Q≥200+10C			
		Size	Dielectric X5R/X7R/	Rated 6.3V,	Capacitance	Rated	D.F.≦		Exception of D.F.≦	
		0201	X6S	10V	C≧0.1µF			≦6%	1206≧0.47µF	
		0402	X5R/X7R/	6.3V,	C≧1µF	≧100V	≦3%	≦7.5%	0805≧0.1µF, 0603≧0.068µF	
			X6S	10V 4V	C≧22µF			≦6%	0201(50V);0603≧0.047μF; 0805≧0.18μF; 1206≧0.47μF	
		0603	X5R/X7R/ X6S	6.3V, 10V	C≧4.7µF	≧50V	≦3%	≦10%	1210≧4.7µF	
				35V	C≧1µF			≦20%	0402≧0.1μF;0603≧1μF; 0805≧1μF; 1206≧2.2μF; 1210≧10μF; TT series	
		0805	X5R/X7R/ X6S	4V	C≧47µF	35V	≦5%	≦20%	0603≧1μF; 0805≥2.2μF;1210≧10μF	
	High Temperature Load (Endurance)		X5R/X7R/	6.3V 6.3V	C≧22µF			≦10%	0201≧0.01μF;0805≧1μF; 1210≧10μF	
15		1206	NP0	3000V	C≧47µF Cv1.5pF			≦14%	0603≧0.33μF;1206≧4.7μF	
		TT18	Y5V	6.3V,10	C≧2.2µF	25V	≦5%	≦15%	0402≧0.10μF;0603≧0.47μF;0805≧2.2μF; 1206≧6.8μF; 1210≧22μF; TT series	
		TT21	Y5V	6.3V	C≧10µF			≦20%	0402≧1µF	
		(6)15	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		C≧22µF for below			≦10%	0603≥0.15μF;0805≥0.68μF;1206≥2.2μF; 1210≥4.7μF	
			ra	inge.		16V	≦5%		0201≧0.01µF;0402≧0.033µF;0603≧0.68µ	
		Size	Dielectric	Rated voltage	Capacitance range			≦15%	F;0805≧2.2μF; 1206≧4.7μF; 1210≧22μF; TT series	
		0201	X5R/X7R/ X6S	16V	C≧0.1µF			≦15%	0201≧0.012μF; 0402≧0.33μF; 0603≧0.33μF;0805≧2.2μF; 1206≧2.2μF;	
			X5R/X7R/	50V	C≧0.1µF	10V	≦7.5%		1210≧22µF	
		0402	X6S	10V~25V	C≧0.22µF			≦20%	0201≧0.1μF ;0402≧1μF;	
			Y5V	16V	C≧0.47µF				TT series	
		0603	X5R/X7R/ X6S	10V,50V	C≧1.0µF	6.3V	≦15%	≦30%	0201≥0.1μF;0402≥1μF;0603≥10μF; 0805≥4.7μF;1206≥47μF;1210≥100μF; TT series	
			Y5V	16V	C≧2.2µF	4V	≦20%	_	-	
			X5R/X7R/ X6S	10~50V	C≧4.7µF		<u> =2070</u>			
		0805	0805 X7R	50V	C≧2.2µF					
				100V	C≧0.47µF					
			Y5V	16V	C≧4.7µF					
		2220	X7R	100V	C≧6.8µF					







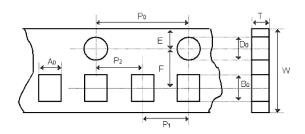
No	Item	Test Condition	Requirements					
			Y5V:					
			Rated vol.	D.F.≦		Exception of D	.F.≦	
			≥50V	7.5%	10%	0603≧0 0805≧0.47µF;		
			35V	10%	-	-		
			25V	7.5%	0402≧0.047µF;; 10% 0805≧0.33µF; 1210≧4		;1206≧1µF;	
					15%	0402≧0.068µF;0 1206≧4.7µF;		
			16V	10%	12.5%	0402≧0.068µF;	0603≧0.68µF	
		High emperature Load Endurance)	(C<1µF)	1076	20%	0402≧0.22µF		
			16V (C≧1µF)	12.5%	20%	0603≥2.2μF; 0805≥3.3μI 1206≥10μF;1210≥22μF 1812≥47μF;		
			10V	20%	30%	0402≧0.47µF		
	Load		6.3V	30%	-	-		
	(Endurance)		*I.R.: ≥10V, 1GΩ or 50 Ω-F whichever is smaller. Class II (X7R, X5R, X6S, Y5V)					
				Insulation Resistance				
				100V: X7R				
			50V: 040					
			35V: 0603≥1µF; 0805≥2.2µF;1210≥10µF					
			25V:0402≥1μF;0603≥2.2μF;0805≥2.2μF;1 $1G\Omega$ or $R\times C \ge 10\mu$ F;1210≥10μF whichever is					
			wnicneve				smaller.	
			10V:0201≥47nF;0402≥0.47µF;0603≥0.47µF;0 805≥2.2µF; 1206≥4.7µF;1210≥47µF					
	6.3V; 4V							



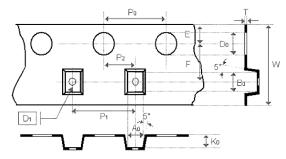


# Appendixes:

### **Tape & Reel Dimensions**



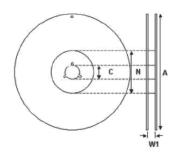
The dimension of paper tape



The dimension of plastic tape

Size	0402	0603		0805		1206			12	1812	
Thickness	N	S, X	Α	В	C, D, I	В	C, J, D	G	C, D, G	М	D, K
A <sub>0</sub>	0.7±0.1	1.02 ±0.05	1.5 ±0.1	1.5 ±0.1	<1.57	2 ±0.1	<1.85	<1.95	<2.97	<2.97	<3.81
В0	1.12±0.05	1.8 ±0.05	2.3 ±0.1	2.3 ±0.1	<2.4	3.5 ±0.1	<3.46	<3.67	<3.73	<3.73	<5.3
Т	0.6±0.05	0.95 ±0.05	0.75 ±0.05	0.95 ±0.05	0.23 ±0.05	0.95 ±0.05	0.23±0.05	0.23 ±0.05	0.23 ±0.05	0.23 ±0.05	0.25±0.05
K <sub>0</sub>	-	-	-	-	<2.5	-	<2.5	<2.5	<2.5	<3	<2.5
W	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	8 ±0.1	12 ±0.2
P <sub>0</sub>	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1
10xP <sub>0</sub>	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1	40 ±0.1
P1	2 ±0.05	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	4 ±0.1	8 ±0.1
P <sub>2</sub>	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05	2 ±0.05
D <sub>0</sub>	1.55±0.05	1.55 ±0.05	1.55 ±0.05	1.55±0.05	1.5 ±0.05	1.5 ±0.05	1.5 ±0.05	1.5 ±0.05	1.5 ±0.05	1.5 ±0.05	1.5 ±0.05
D1	-	-	-	-	1 ±0.1	-	1 ±0.1	1 ±0.1	1 ±0.1	1 ±0.1	1.5 ±0.1
Е	1.75±0.05	1.75 ±0.05	1.75 ±0.05	1.75 ±0.05	1.75 ±0.1	1.75 ±0.1	1.75 ±0.1	1.75 ±0.1	1.75 ±0.1	1.75 ±0.1	1.75 ±0.1
F	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	3.5 ±0.05	5.5 ±0.05

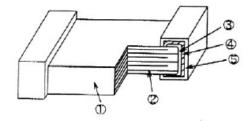




Size	0402,	1812		
Reel size	7"	10"	13"	7"
С	13 +0.5/-0.2	13 +0.5/-0.2	13 +0.5/-0.2	13 +0.5/-0.2
W <sub>1</sub>	8.4 +1.5/-0	8.4 +1.5/-0	8.4 +1.5/-0	12.4 +2/-0
А	178 ±0.1	250 ±1	330 ±1	178 ±0.1
N	60 +1/-0	100 ±1	100 ±1	60 +1/-0

The dimension of reel

### **Constructions:**



No.	Na	me	NPO, X7R, X5R, Y5V
1	Ceramic	material	BaTiO₃ based
2	Inner el	ectrode	Ni
3		Inner layer	Cu
4	Termination	Middle layer	Ni
5		Outer layer	Sn

### Storage and handling conditions

- (1) To store products at 5°C to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

### Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.

Page <14>

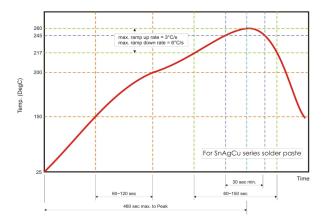
c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.



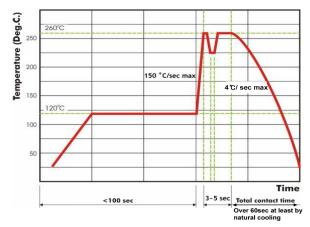


## **Recommended Soldering Conditions:**

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of  $N_2$  within oven are recommended.



Recommended reflow soldering profile for SMT process with SnAgCu series solder paste.



Recommended wave soldering profile for SMT process with SnAgCu series solder.

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